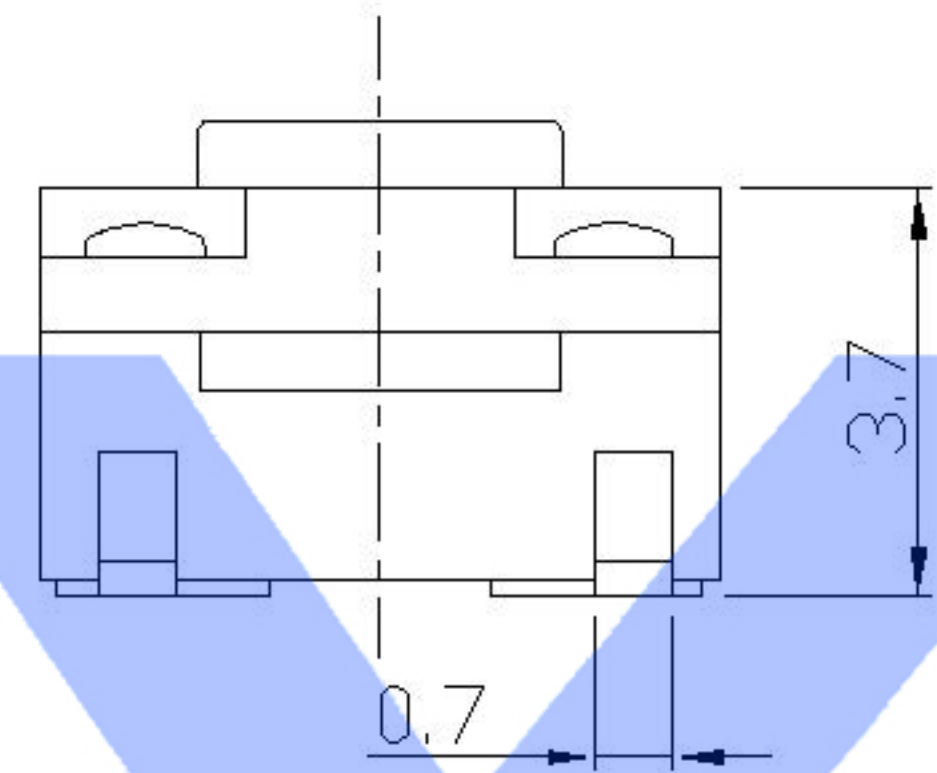
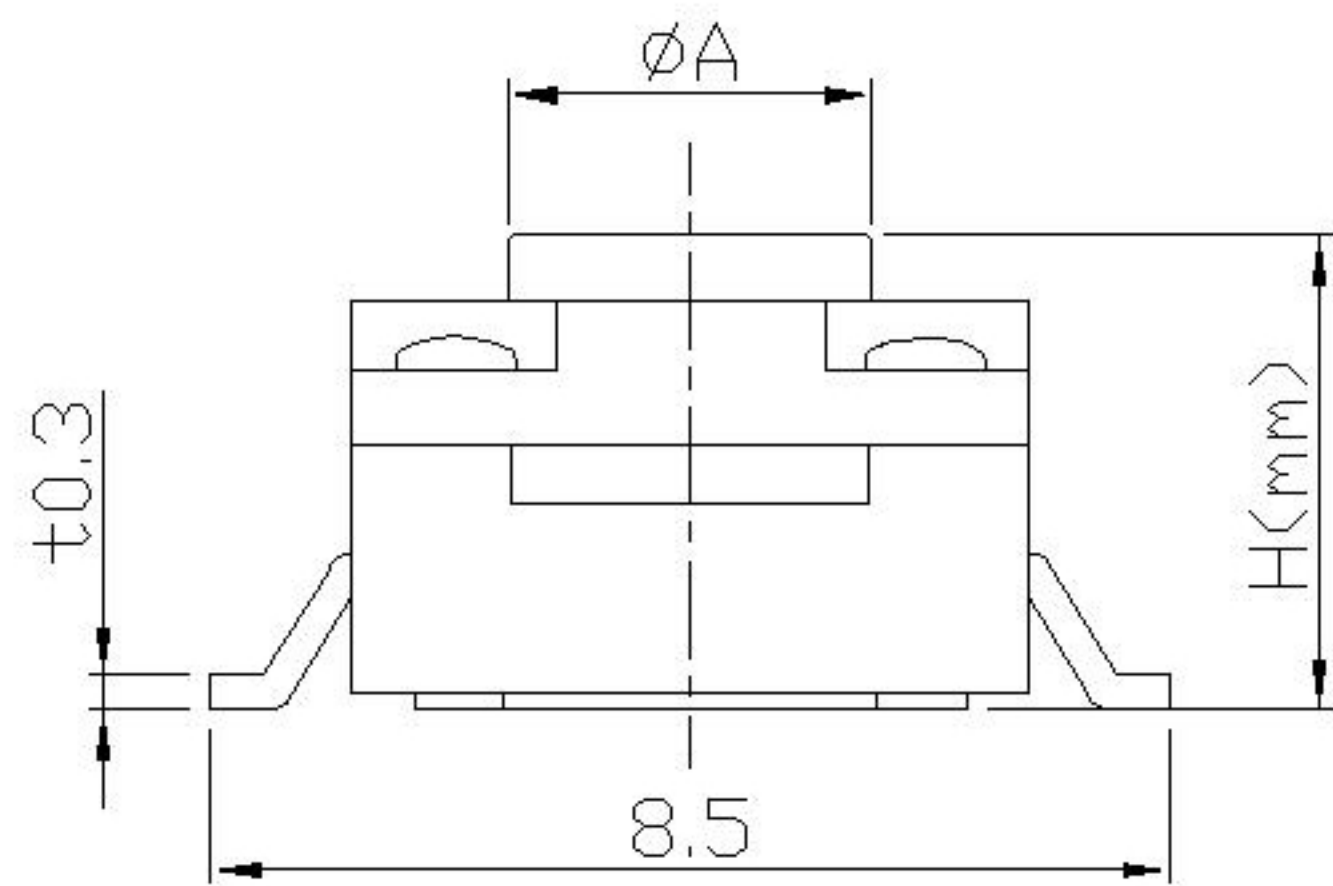
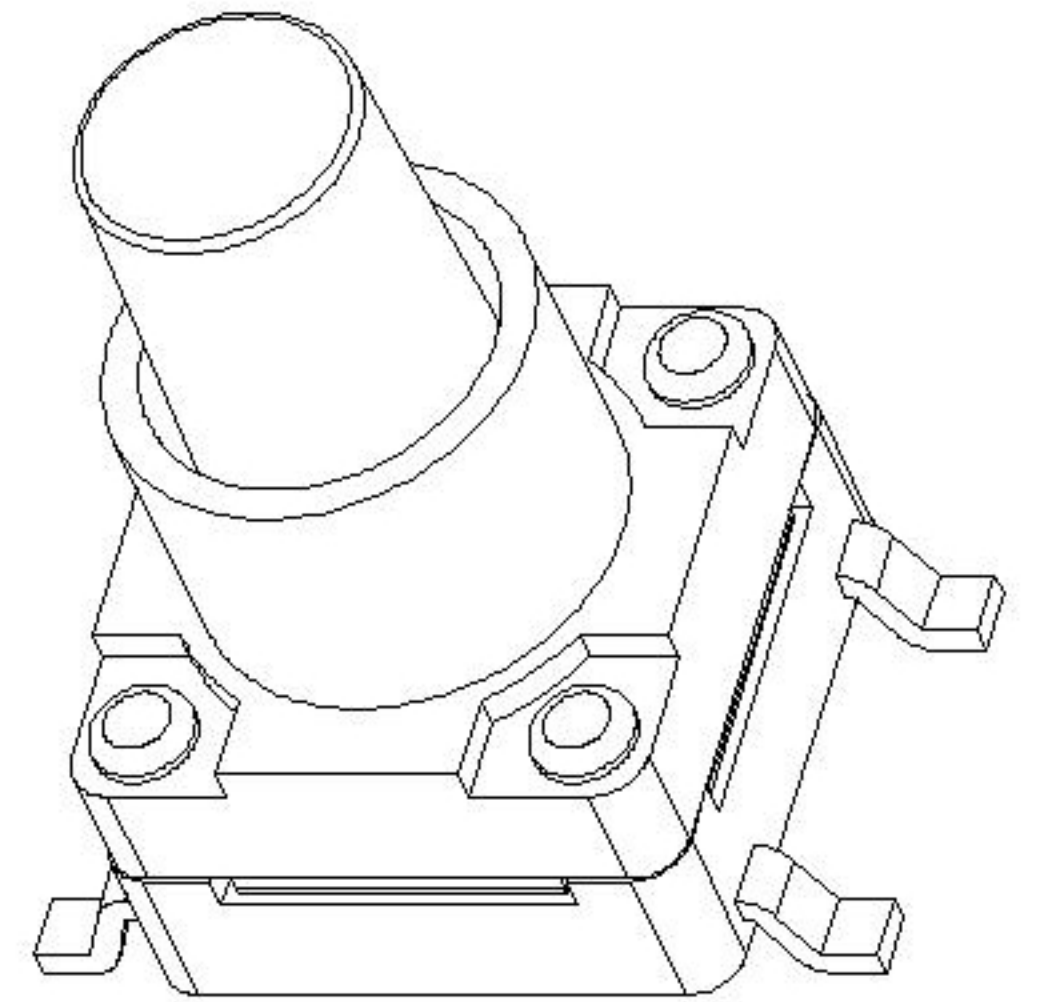
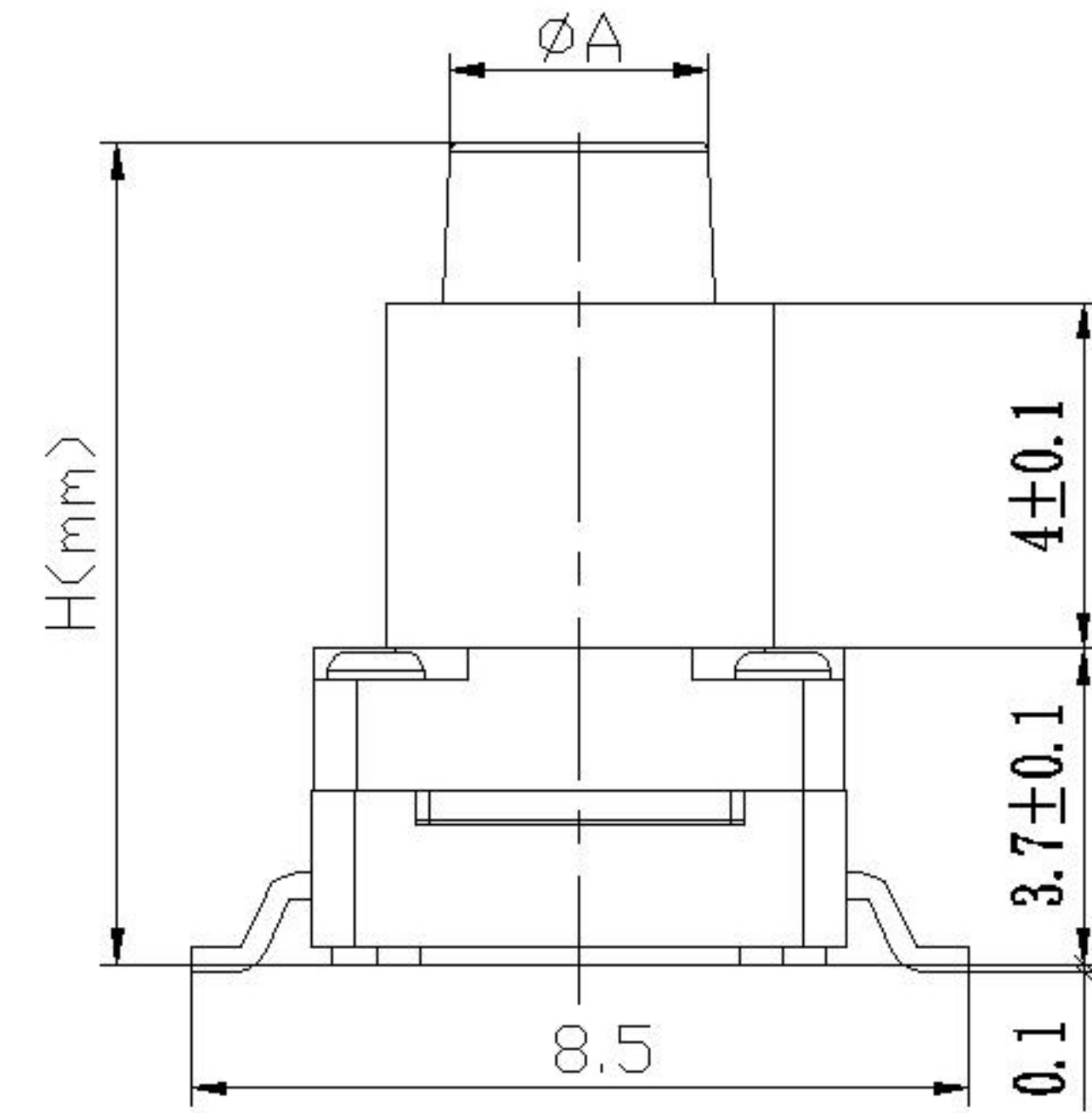


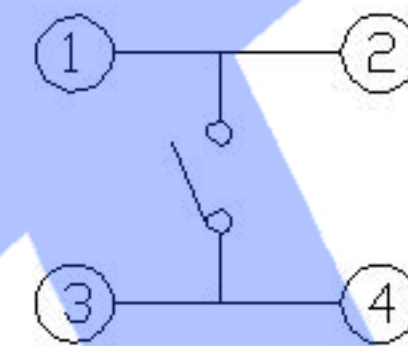
DIMENSIONS



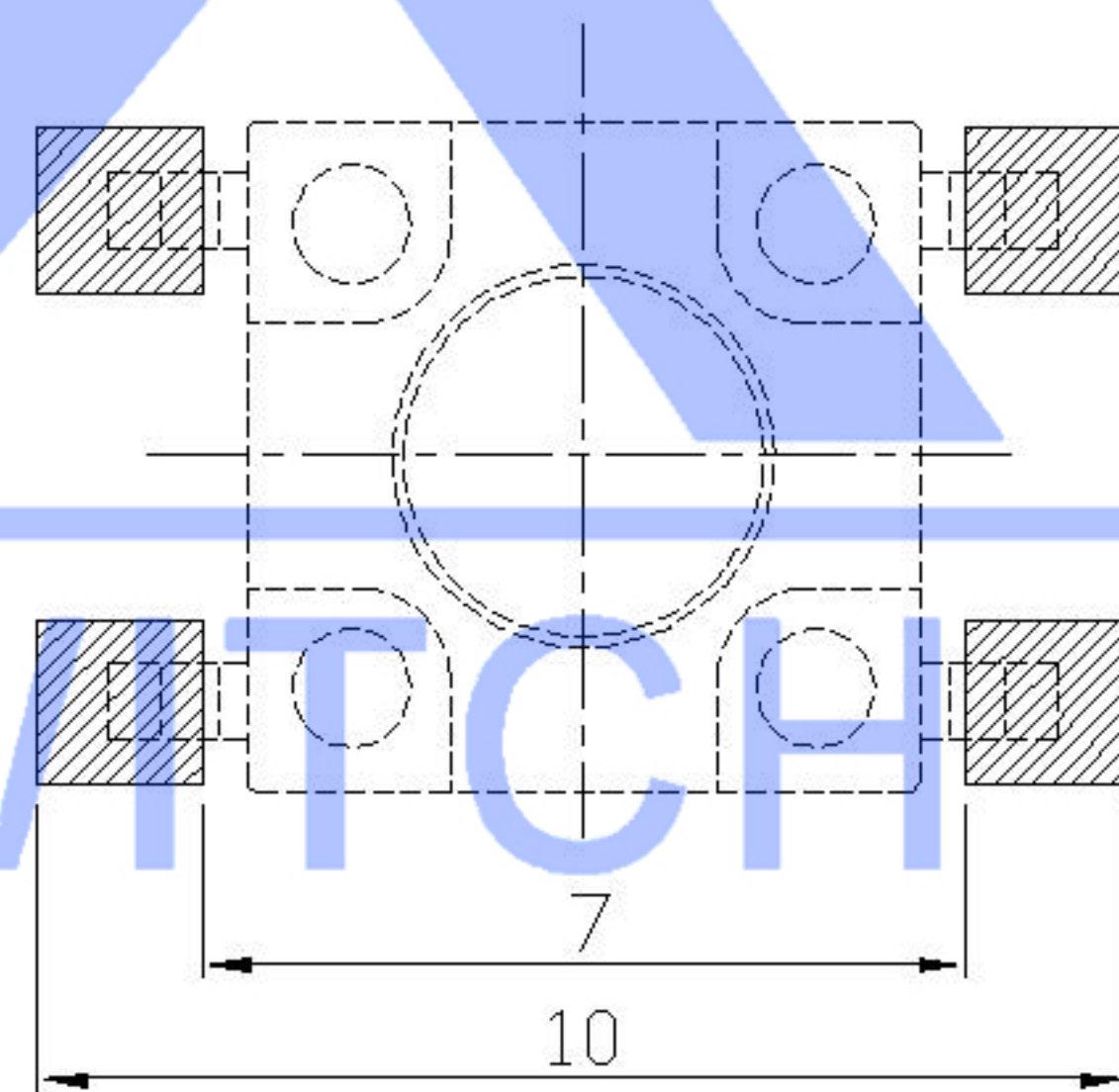
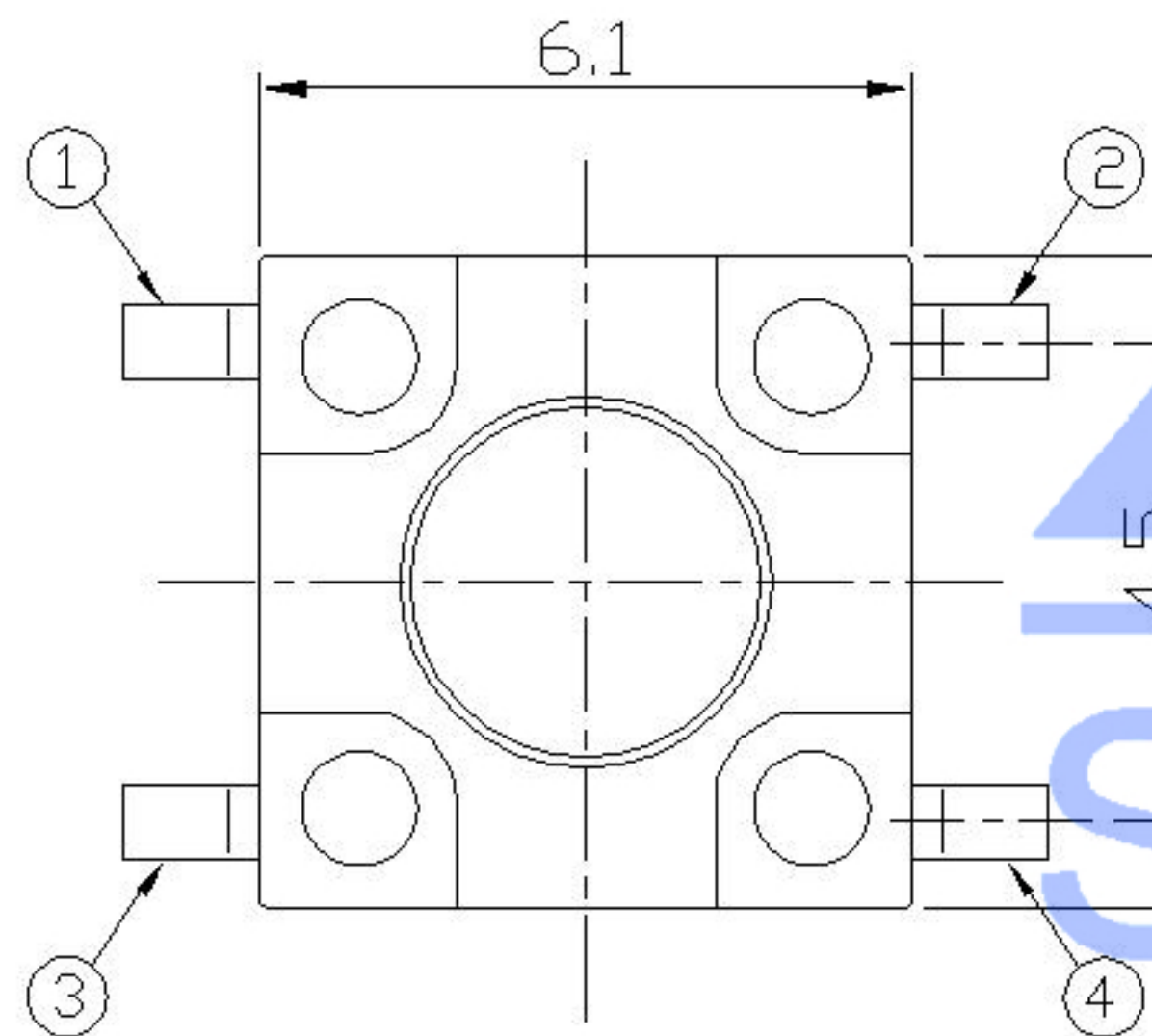
Code-X	H	Code-X	H
A	4.3	O	11.0
B	4.5	P	11.5
C	5.0	Q	12
D	5.5	R	12.5
E	6.0	S	13.0
F	6.5	T	13.5
G	7.0	U	14.0
H	7.5	V	15.0
I	8.0	W	15.5
J	8.5	X	16
K	9.0	Y	16.5
L	9.5	Z	17
M	10.0	18	18
N	10.5	19	19



CIRCUIT DIAGRAM



P.C.B MOUNTING PATTERN DIMENSION
The following soldering patterns are recommended for reflow soldering



SPECIFICATION

Contact Rating 50mA 12V DC
Contact Resistance 100mΩ max.
Insulation Resistance 100MΩ min. 500V DC
Dielectric Strength 250V AC/1 minute
Travel 0.25mm
Operating Temp. -25 C +70 C
Storage Temp. -30 C +80 C

PAPT NO	TS-FS66T-X-X
Operating Force	A:100gf B:160gf C:260gf
Height	Code-X

⑤	Terminal	—	4	Brass (0.30t)	ag Plated	—
④	Contact	—	1	F.ag/SUS		—
③	Base	—	1	PA46		—
②	Cover	—	1	Brass	Tin plated	—
①	Keystake	—	1	PA46		—
ITEM	PAPT NAMF	TER.NO	QTY	MATERIAL	FINISHING	REMARK

					units: mm
△X					tolerance:
△X					X.X ±0.2mm
△X					X.XX ±0.1mm
MARK	DESCRIPTION	DATE	REVISED	APPROVED	X.XXX ±0.05mm
REVISIONS					UNSPECIFIED TOLERANCES
www.xk-dg.cn www.helloxkb.com www.helloxkb.cn					

DSND		DATE		SCALE: N/A	MODEL TYPE:
DWN		DATE		VIEW:	TACT SWITCH
CHKD		DATE		UNIT: mm	PART NO.:
APPD		DATE		SIZE: A4	DWG NO.:
XKB INDUSTRIAL PRECISION CO.,LIMITED				WEIGHT	TS-FS66T-X-X
				1.0g	SHEET
					1/1
					REVISION
					A0